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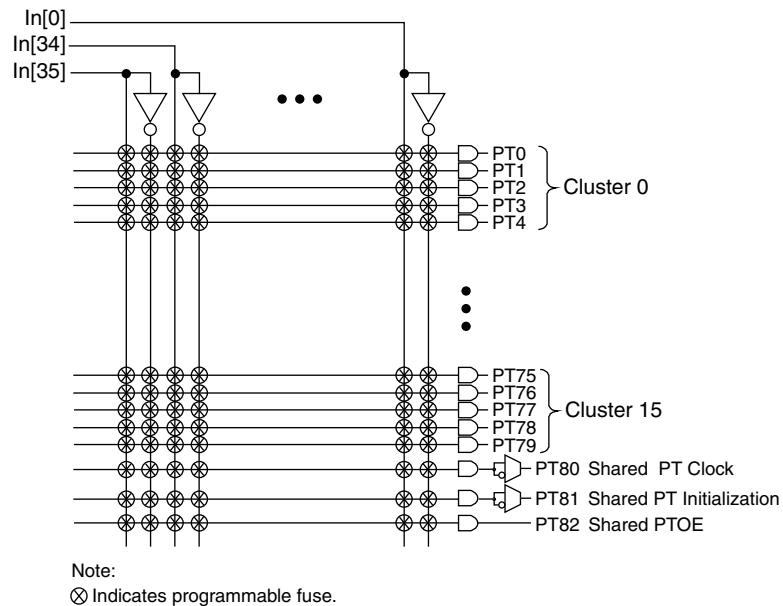
Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 5 ns |
| Voltage Supply - Internal | 1.65V ~ 1.95V |
| Number of Logic Elements/Blocks | 4 |
| Number of Macrocells | 64 |
| Number of Gates | - |
| Number of I/O | 64 |
| Operating Temperature | 0°C ~ 90°C (TJ) |
| Mounting Type | Surface Mount |
| Package / Case | 100-LQFP |
| Supplier Device Package | 100-TQFP (14x14) |
| Purchase URL | https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064c-5tn100c |

Figure 3. AND Array

Enhanced Logic Allocator

Within the logic allocator, product terms are allocated to macrocells in product term clusters. Each product term cluster is associated with a macrocell. The cluster size for the ispMACH 4000 family is 4+1 (total 5) product terms. The software automatically considers the availability and distribution of product term clusters as it fits the functions within a GLB. The logic allocator is designed to provide three speed paths: 5-PT fast bypass path, 20-PT Speed Locking path and an up to 80-PT path. The availability of these three paths lets designers trade timing variability for increased performance.

The enhanced Logic Allocator of the ispMACH 4000 family consists of the following blocks:

- Product Term Allocator
- Cluster Allocator
- Wide Steering Logic

Figure 4 shows a macrocell slice of the Logic Allocator. There are 16 such slices in the GLB.

Figure 4. Macrocell Slice

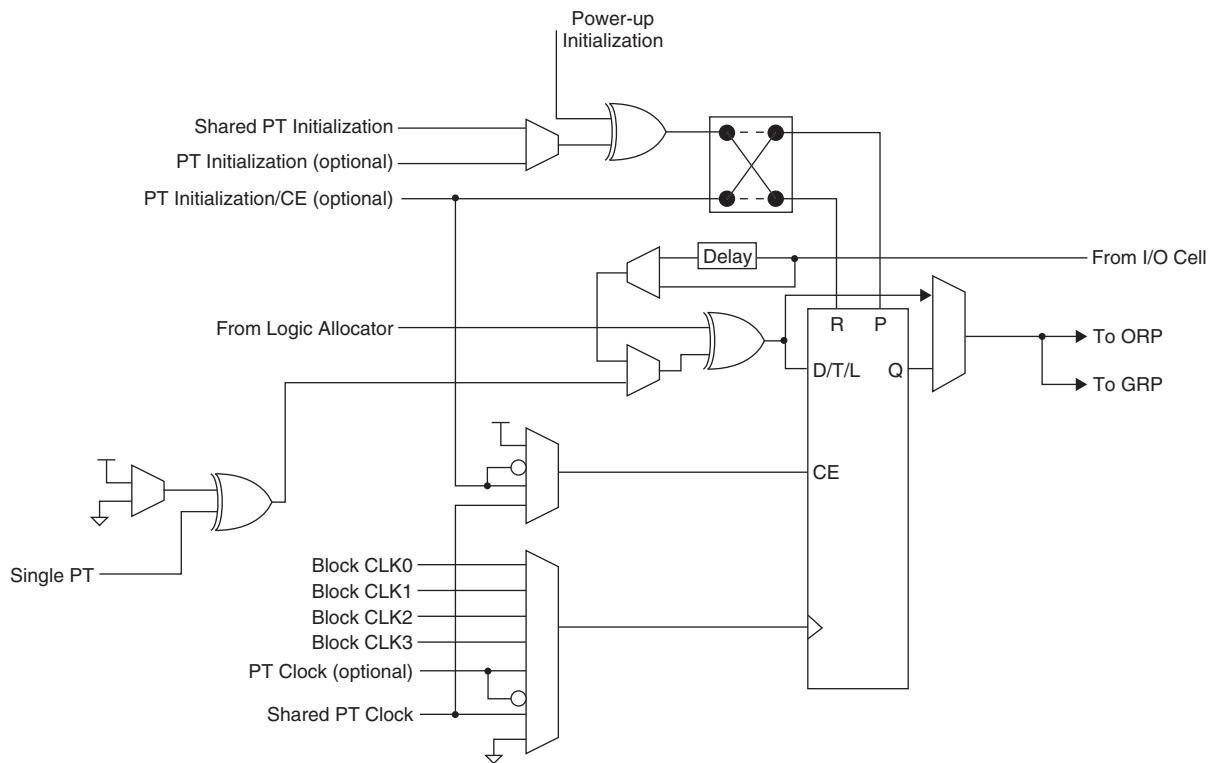
Table 5. Product Term Expansion Capability

| Expansion Chains | Macrocells Associated with Expansion Chain (with Wrap Around) | Max PT/Macrocell |
|------------------|---|------------------|
| Chain-0 | M0 M4 M8 M12 M0 | 75 |
| Chain-1 | M1 M5 M9 M13 M1 | 80 |
| Chain-2 | M2 M6 M10 M14 M2 | 75 |
| Chain-3 | M3 M7 M11 M15 M3 | 70 |

Every time the super cluster allocator is used, there is an incremental delay of t_{EXP} . When the super cluster allocator is used, all destinations other than the one being steered to, are given the value of ground (i.e., if the super cluster is steered to M (n+4), then M (n) is ground).

Macrocell

The 16 macrocells in the GLB are driven by the 16 outputs from the logic allocator. Each macrocell contains a programmable XOR gate, a programmable register/latch, along with routing for the logic and control functions. Figure 5 shows a graphical representation of the macrocell. The macrocells feed the ORP and GRP. A direct input from the I/O cell allows designers to use the macrocell to construct high-speed input registers. A programmable delay in this path allows designers to choose between the fastest possible set-up time and zero hold time.

Figure 5. Macrocell

Enhanced Clock Multiplexer

The clock input to the flip-flop can select any of the four block clocks along with the shared PT clock, and true and complement forms of the optional individual term clock. An 8:1 multiplexer structure is used to select the clock. The eight sources for the clock multiplexer are as follows:

- Block CLK0
- Block CLK1

- LVTTL
- LVC MOS 1.8
- LVC MOS 3.3
- 3.3V PCI Compatible
- LVC MOS 2.5

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, Pull-up Resistor or Pull-down Resistor. A fourth option is to provide none of these. The selection is done on a global basis. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-up Resistor.

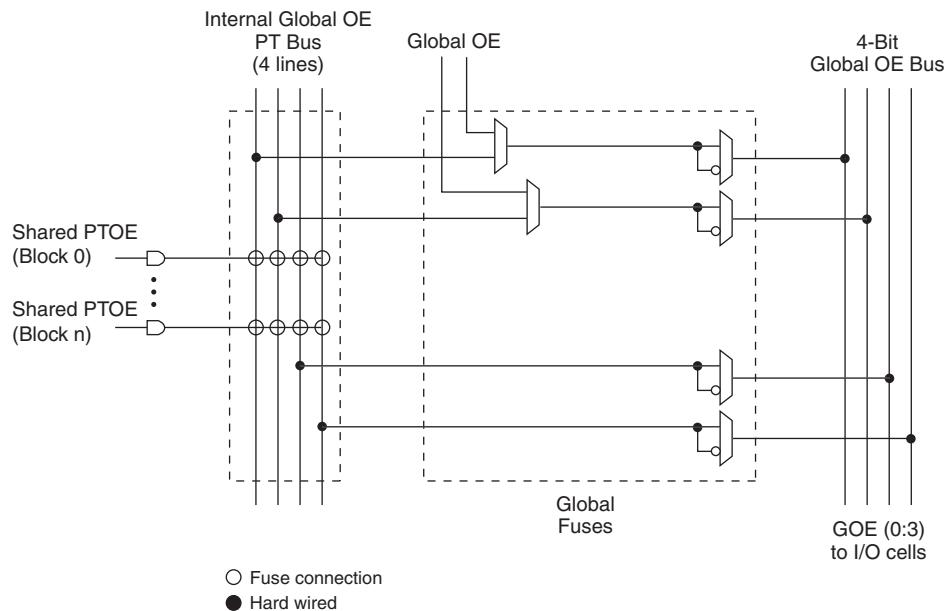
Each ispMACH 4000 device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

Global OE Generation

Most ispMACH 4000 family devices have a 4-bit wide Global OE Bus, except the ispMACH 4032 device that has a 2-bit wide Global OE Bus. This bus is derived from a 4-bit internal global OE PT bus and two dual purpose I/O or GOE pins. Each signal that drives the bus can optionally be inverted.

Each GLB has a block-level OE PT that connects to all bits of the Global OE PT bus with four fuses. Hence, for a 256-macrocell device (with 16 blocks), each line of the bus is driven from 16 OE product terms. Figures 9 and 10 show a graphical representation of the global OE generation.

Figure 9. Global OE Generation for All Devices Except ispMACH 4032



IEEE 1532-Compliant In-System Programming

Programming devices in-system provides a number of significant benefits including: rapid prototyping, lower inventory levels, higher quality and the ability to make in-field modifications. All ispMACH 4000 devices provide In-System Programming (ISP™) capability through the Boundary Scan Test Access Port. This capability has been implemented in a manner that ensures that the port remains complaint to the IEEE 1149.1 standard. By using IEEE 1149.1 as the communication interface through which ISP is achieved, users get the benefit of a standard, well-defined interface. All ispMACH 4000 devices are also compliant with the IEEE 1532 standard.

The ispMACH 4000 devices can be programmed across the commercial temperature and voltage range. The PC-based Lattice software facilitates in-system programming of ispMACH 4000 devices. The software takes the JEDEC file output produced by the design implementation software, along with information about the scan chain, and creates a set of vectors used to drive the scan chain. The software can use these vectors to drive a scan chain via the parallel port of a PC. Alternatively, the software can output files in formats understood by common automated test equipment. This equipment can then be used to program ispMACH 4000 devices during the testing of a circuit board.

User Electronic Signature

The User Electronic Signature (UES) allows the designer to include identification bits or serial numbers inside the device, stored in E²CMOS memory. The ispMACH 4000 device contains 32 UES bits that can be configured by the user to store unique data such as ID codes, revision numbers or inventory control codes.

Security Bit

A programmable security bit is provided on the ispMACH 4000 devices as a deterrent to unauthorized copying of the array configuration patterns. Once programmed, this bit defeats readback of the programmed pattern by a device programmer, securing proprietary designs from competitors. Programming and verification are also defeated by the security bit. The bit can only be reset by erasing the entire device.

Hot Socketing

The ispMACH 4000 devices are well-suited for applications that require hot socketing capability. Hot socketing a device requires that the device, during power-up and down, can tolerate active signals on the I/Os and inputs without being damaged. Additionally, it requires that the effects of I/O pin loading be minimal on active signals. The ispMACH 4000 devices provide this capability for input voltages in the range 0V to 3.0V.

Density Migration

The ispMACH 4000 family has been designed to ensure that different density devices in the same package have the same pin-out. Furthermore, the architecture ensures a high success rate when performing design migration from lower density parts to higher density parts. In many cases, it is possible to shift a lower utilization design targeted for a high density device to a lower density device. However, the exact details of the final resource utilization will impact the likely success in each case.

I/O Recommended Operating Conditions

| Standard | V_{CCO} (V) ¹ | |
|-----------------------------------|----------------------------|------|
| | Min. | Max. |
| LV TTL | 3.0 | 3.6 |
| LVC MOS 3.3 | 3.0 | 3.6 |
| Extended LVC MOS 3.3 ² | 2.7 | 3.6 |
| LVC MOS 2.5 | 2.3 | 2.7 |
| LVC MOS 1.8 | 1.65 | 1.95 |
| PCI 3.3 | 3.0 | 3.6 |

1. Typical values for V_{CCO} are the average of the min. and max. values.

2. ispMACH 4000Z only.

DC Electrical Characteristics

Over Recommended Operating Conditions

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|------------------------|---|--|------------------|------|------------------|---------|
| $I_{IL}, I_{IH}^{1,4}$ | Input Leakage Current (ispMACH 4000Z) | $0 \leq V_{IN} < V_{CCO}$ | — | 0.5 | 1 | μA |
| I_{IH}^1 | Input High Leakage Current (ispMACH 4000Z) | $V_{CCO} < V_{IN} \leq 5.5V$ | — | — | 10 | μA |
| I_{IL}, I_{IH}^1 | Input Leakage Current (ispMACH 4000V/B/C) | $0 \leq V_{IN} \leq 3.6V, T_j = 105^\circ C$ $0 \leq V_{IN} \leq 3.6V, T_j = 130^\circ C$ | — | — | 10 | μA |
| $I_{IH}^{1,2}$ | Input High Leakage Current (ispMACH 4000V/B/C) | $3.6V < V_{IN} \leq 5.5V, T_j = 105^\circ C$ $3.0V \leq V_{CCO} \leq 3.6V$ $3.6V < V_{IN} \leq 5.5V, T_j = 130^\circ C$ $3.0V \leq V_{CCO} \leq 3.6V$ | — | — | 20 | μA |
| I_{PU} | I/O Weak Pull-up Resistor Current (ispMACH 4000Z) | $0 \leq V_{IN} \leq 0.7V_{CCO}$ | -30 | — | -150 | μA |
| I_{PU} | I/O Weak Pull-up Resistor Current (ispMACH 4000V/B/C) | $0 \leq V_{IN} \leq 0.7V_{CCO}$ | -30 | — | -200 | μA |
| I_{PD} | I/O Weak Pull-down Resistor Current | $V_{IL} (\text{MAX}) \leq V_{IN} \leq V_{IH} (\text{MIN})$ | 30 | — | 150 | μA |
| I_{BHLS} | Bus Hold Low Sustaining Current | $V_{IN} = V_{IL} (\text{MAX})$ | 30 | — | — | μA |
| I_{BHHS} | Bus Hold High Sustaining Current | $V_{IN} = 0.7 V_{CCO}$ | -30 | — | — | μA |
| I_{BHLO} | Bus Hold Low Overdrive Current | $0V \leq V_{IN} \leq V_{BHT}$ | — | — | 150 | μA |
| I_{BHHO} | Bus Hold High Overdrive Current | $V_{BHT} \leq V_{IN} \leq V_{CCO}$ | — | — | -150 | μA |
| V_{BHT} | Bus Hold Trip Points | — | $V_{CCO} * 0.35$ | — | $V_{CCO} * 0.65$ | V |
| C_1 | I/O Capacitance ³ | $V_{CCO} = 3.3V, 2.5V, 1.8V$ $V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (\text{MAX})$ | — | 8 | — — | pf |
| C_2 | Clock Capacitance ³ | $V_{CCO} = 3.3V, 2.5V, 1.8V$ $V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (\text{MAX})$ | — | 6 | — — | pf |
| C_3 | Global Input Capacitance ³ | $V_{CCO} = 3.3V, 2.5V, 1.8V$ $V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (\text{MAX})$ | — | 6 | — — | pf |

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tristated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. 5V tolerant inputs and I/O should only be placed in banks where $3.0V \leq V_{CCO} \leq 3.6V$.

3. $T_A = 25^\circ C, f = 1.0MHz$

4. I_{IH} excursions of up to $1.5\mu A$ maximum per pin above the spec limit may be observed for certain voltage conditions on no more than 10% of the device's I/O pins.

Supply Current, ispMACH 4000Z (Cont.)

Over Recommended Operating Conditions

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|---------------------------|--------------------------------|------------------------|------|------|------|-------|
| ispMACH 4256ZC | | | | | | |
| ICC ^{1, 2, 3, 5} | Operating Power Supply Current | Vcc = 1.8V, TA = 25°C | — | 341 | — | µA |
| | | Vcc = 1.9V, TA = 70°C | — | 361 | — | µA |
| | | Vcc = 1.9V, TA = 85°C | — | 372 | — | µA |
| | | Vcc = 1.9V, TA = 125°C | — | 468 | — | µA |
| ICC ^{4, 5} | Standby Power Supply Current | Vcc = 1.8V, TA = 25°C | — | 13 | — | µA |
| | | Vcc = 1.9V, TA = 70°C | — | 32 | 55 | µA |
| | | Vcc = 1.9V, TA = 85°C | — | 43 | 90 | µA |
| | | Vcc = 1.9V, TA = 125°C | — | 135 | — | µA |

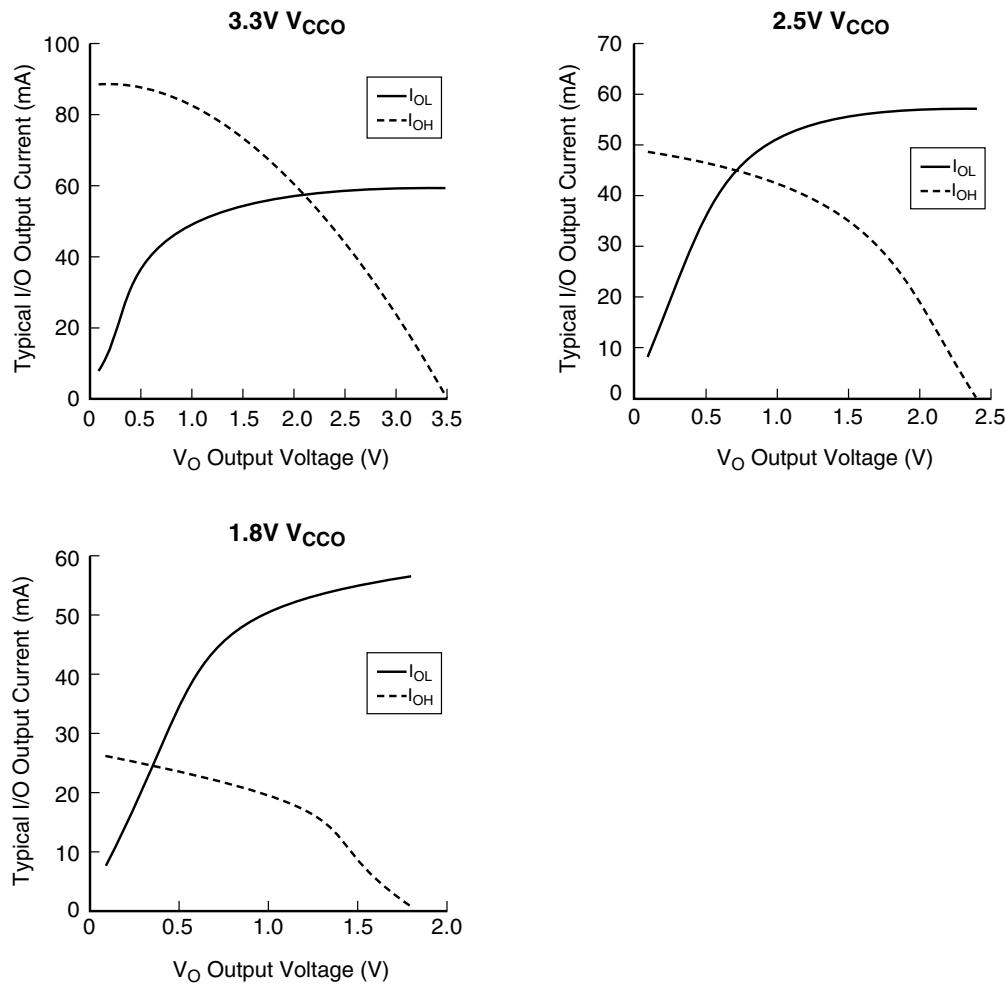
1. TA = 25°C, frequency = 1.0 MHz.

2. Device configured with 16-bit counters.

3. ICC varies with specific device configuration and operating frequency.

4. VCCO = 3.6V, VIN = 0V or VCCO, bus maintenance turned off. VIN above VCCO will add transient current above the specified standby ICC.

5. Includes VCCO current without output loading.



ispMACH 4000Z Internal Timing Parameters (Cont.)**Over Recommended Operating Conditions**

| Parameter | Description | -35 | | -37 | | -42 | | Units |
|-------------|-----------------------|------|------|------|------|------|------|-------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| t_{GPTOE} | Global PT OE Delay | — | 1.9 | — | 2.35 | — | 2.60 | ns |
| t_{PTOE} | Macrocell PT OE Delay | — | 2.4 | — | 3.35 | — | 2.60 | ns |

Note: Internal Timing Parameters are not tested and are for reference only. Refer to the timing model in this data sheet for further details.

Timing v.2.2

ispMACH 4000V/B/C Timing Adders¹

| Adder Type | Base Parameter | Description | -25 | | -27 | | -3 | | -35 | | Units |
|--|---------------------------------------|--|------|------|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Max. | |
| Optional Delay Adders | | | | | | | | | | | |
| t_{INDIO} | t_{INREG} | Input register delay | — | 0.95 | — | 1.00 | — | 1.00 | — | 1.00 | ns |
| t_{EXP} | t_{MCELL} | Product term expander delay | — | 0.33 | — | 0.33 | — | 0.33 | — | 0.33 | ns |
| t_{ORP} | — | Output routing pool delay | — | 0.05 | — | 0.05 | — | 0.05 | — | 0.05 | ns |
| t_{BLA} | t_{ROUTE} | Additional block loading adder | — | 0.03 | — | 0.05 | — | 0.05 | — | 0.05 | ns |
| t_{IOI} Input Adjusters | | | | | | | | | | | |
| LVTTL_in | t_{IN} , t_{GCLK_IN} , t_{GOE} | Using LVTTL standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS33_in | t_{IN} , t_{GCLK_IN} , t_{GOE} | Using LVCMOS 3.3 standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS25_in | t_{IN} , t_{GCLK_IN} , t_{GOE} | Using LVCMOS 2.5 standard | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS18_in | t_{IN} , t_{GCLK_IN} , t_{GOE} | Using LVCMOS 1.8 standard | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_in | t_{IN} , t_{GCLK_IN} , t_{GOE} | Using PCI compatible input | — | 0.60 | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| t_{IOO} Output Adjusters | | | | | | | | | | | |
| LVTTL_out | t_{BUF} , t_{EN} , t_{DIS} | Output configured as TTL buffer | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVCMOS33_out | t_{BUF} , t_{EN} , t_{DIS} | Output configured as 3.3V buffer | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVCMOS25_out | t_{BUF} , t_{EN} , t_{DIS} | Output configured as 2.5V buffer | — | 0.10 | — | 0.10 | — | 0.10 | — | 0.10 | ns |
| LVCMOS18_out | t_{BUF} , t_{EN} , t_{DIS} | Output configured as 1.8V buffer | — | 0.00 | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_out | t_{BUF} , t_{EN} , t_{DIS} | Output configured as PCI compatible buffer | — | 0.20 | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| Slow Slew | t_{BUF} , t_{EN} | Output configured for slow slew rate | — | 1.00 | — | 1.00 | — | 1.00 | — | 1.00 | ns |

Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000Z Timing Adders (Cont.)¹

| Adder Type | Base Parameter | Description | -45 | | -5 | | -75 | | Units |
|---|---|--|------|------|------|------|------|------|-------|
| | | | Min. | Max. | Min. | Max. | Min. | Max. | |
| Optional Delay Adders | | | | | | | | | |
| t _{INDIO} | t _{INREG} | Input register delay | — | 1.30 | — | 1.30 | — | 1.30 | ns |
| t _{EXP} | t _{MCELL} | Product term expander delay | — | 0.45 | — | 0.45 | — | 0.50 | ns |
| t _{ORP} | — | Output routing pool delay | — | 0.40 | — | 0.40 | — | 0.40 | ns |
| t _{BLA} | t _{ROUTE} | Additional block loading adder | — | 0.05 | — | 0.05 | — | 0.05 | ns |
| t_{IOL} Input Adjusters | | | | | | | | | |
| LVTTL_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVTTL standard | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS33_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVCMOS 3.3 standard | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS25_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVCMOS 2.5 standard | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| LVCMOS18_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using LVCMOS 1.8 standard | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_in | t _{IN} , t _{GCLK_IN} , t _{GOE} | Using PCI compatible input | — | 0.60 | — | 0.60 | — | 0.60 | ns |
| t_{IOO} Output Adjusters | | | | | | | | | |
| LVTTL_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as TTL buffer | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVCMOS33_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 3.3V buffer | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| LVCMOS25_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 2.5V buffer | — | 0.10 | — | 0.10 | — | 0.10 | ns |
| LVCMOS18_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as 1.8V buffer | — | 0.00 | — | 0.00 | — | 0.00 | ns |
| PCI_out | t _{BUF} , t _{EN} , t _{DIS} | Output configured as PCI compatible buffer | — | 0.20 | — | 0.20 | — | 0.20 | ns |
| Slow Slew | t _{BUF} , t _{EN} | Output configured for slow slew rate | — | 1.00 | — | 1.00 | — | 1.00 | ns |

Note: Open drain timing is the same as corresponding LVCMOS timing.

Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

**ispMACH 4032V/B/C and 4064V/B/C Logic Signal Connections:
44-Pin TQFP**

| Pin Number | Bank Number | ispMACH 4032V/B/C | | ispMACH 4064V/B/C | |
|------------|-------------|-------------------|------|-------------------|-----|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| 1 | - | TDI | - | TDI | - |
| 2 | 0 | A5 | A^5 | A10 | A^5 |
| 3 | 0 | A6 | A^6 | A12 | A^6 |
| 4 | 0 | A7 | A^7 | A14 | A^7 |
| 5 | 0 | GND (Bank 0) | - | GND (Bank 0) | - |
| 6 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| 7 | 0 | A8 | A^8 | B0 | B^0 |
| 8 | 0 | A9 | A^9 | B2 | B^1 |
| 9 | 0 | A10 | A^10 | B4 | B^2 |
| 10 | - | TCK | - | TCK | - |
| 11 | - | VCC | - | VCC | - |
| 12 | - | GND | - | GND | - |
| 13 | 0 | A12 | A^12 | B8 | B^4 |
| 14 | 0 | A13 | A^13 | B10 | B^5 |
| 15 | 0 | A14 | A^14 | B12 | B^6 |
| 16 | 0 | A15 | A^15 | B14 | B^7 |
| 17 | 1 | CLK2/I | - | CLK2/I | - |
| 18 | 1 | B0 | B^0 | C0 | C^0 |
| 19 | 1 | B1 | B^1 | C2 | C^1 |
| 20 | 1 | B2 | B^2 | C4 | C^2 |
| 21 | 1 | B3 | B^3 | C6 | C^3 |
| 22 | 1 | B4 | B^4 | C8 | C^4 |
| 23 | - | TMS | - | TMS | - |
| 24 | 1 | B5 | B^5 | C10 | C^5 |
| 25 | 1 | B6 | B^6 | C12 | C^6 |
| 26 | 1 | B7 | B^7 | C14 | C^7 |
| 27 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 28 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 29 | 1 | B8 | B^8 | D0 | D^0 |
| 30 | 1 | B9 | B^9 | D2 | D^1 |
| 31 | 1 | B10 | B^10 | D4 | D^2 |
| 32 | - | TDO | - | TDO | - |
| 33 | - | VCC | - | VCC | - |
| 34 | - | GND | - | GND | - |
| 35 | 1 | B12 | B^12 | D8 | D^4 |
| 36 | 1 | B13 | B^13 | D10 | D^5 |
| 37 | 1 | B14 | B^14 | D12 | D^6 |
| 38 | 1 | B15/GOE1 | B^15 | D14/GOE1 | D^7 |
| 39 | 0 | CLK0/I | - | CLK0/I | - |
| 40 | 0 | A0/GOE0 | A^0 | A0/GOE0 | A^0 |
| 41 | 0 | A1 | A^1 | A2 | A^1 |

ispMACH 4128V and 4256V Logic Signal Connections: 144-Pin TQFP (Cont.)

| Pin Number | Bank Number | ispMACH 4128V | | ispMACH 4256V | |
|------------|-------------|-----------------|------|----------------|-----|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| 43 | 0 | D9 | D^7 | G4 | G^2 |
| 44 | 0 | D8 | D^6 | G2 | G^1 |
| 45 | 0 | NC ² | - | I ² | - |
| 46 | 0 | GND (Bank 0) | - | GND (Bank 0) | - |
| 47 | 0 | VCCO (Bank 0) | - | VCCO (Bank 0) | - |
| 48 | 0 | D6 | D^5 | H12 | H^6 |
| 49 | 0 | D5 | D^4 | H10 | H^5 |
| 50 | 0 | D4 | D^3 | H8 | H^4 |
| 51 | 0 | D2 | D^2 | H6 | H^3 |
| 52 | 0 | D1 | D^1 | H4 | H^2 |
| 53 | 0 | D0 | D^0 | H2 | H^1 |
| 54 | 0 | CLK1/I | - | CLK1/I | - |
| 55 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 56 | 1 | CLK2/I | - | CLK2/I | - |
| 57 | - | VCC | - | VCC | - |
| 58 | 1 | E0 | E^0 | I2 | I^1 |
| 59 | 1 | E1 | E^1 | I4 | I^2 |
| 60 | 1 | E2 | E^2 | I6 | I^3 |
| 61 | 1 | E4 | E^3 | I8 | I^4 |
| 62 | 1 | E5 | E^4 | I10 | I^5 |
| 63 | 1 | E6 | E^5 | I12 | I^6 |
| 64 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 65 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 66 | 1 | E8 | E^6 | J2 | J^1 |
| 67 | 1 | E9 | E^7 | J4 | J^2 |
| 68 | 1 | E10 | E^8 | J6 | J^3 |
| 69 | 1 | E12 | E^9 | J8 | J^4 |
| 70 | 1 | E13 | E^10 | J10 | J^5 |
| 71 | 1 | E14 | E^11 | J12 | J^6 |
| 72 | 1 | NC ² | - | I ² | - |
| 73 | - | GND | - | GND | - |
| 74 | - | TMS | - | TMS | - |
| 75 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 76 | 1 | F0 | F^0 | K12 | K^6 |
| 77 | 1 | F1 | F^1 | K10 | K^5 |
| 78 | 1 | F2 | F^2 | K8 | K^4 |
| 79 | 1 | F4 | F^3 | K6 | K^3 |
| 80 | 1 | F5 | F^4 | K4 | K^2 |
| 81 | 1 | F6 | F^5 | K2 | K^1 |
| 82 | 1 | GND (Bank 1) | - | GND (Bank 1) | - |
| 83 | 1 | F8 | F^6 | L14 | L^7 |
| 84 | 1 | F9 | F^7 | L12 | L^6 |
| 85 | 1 | F10 | F^8 | L10 | L^5 |

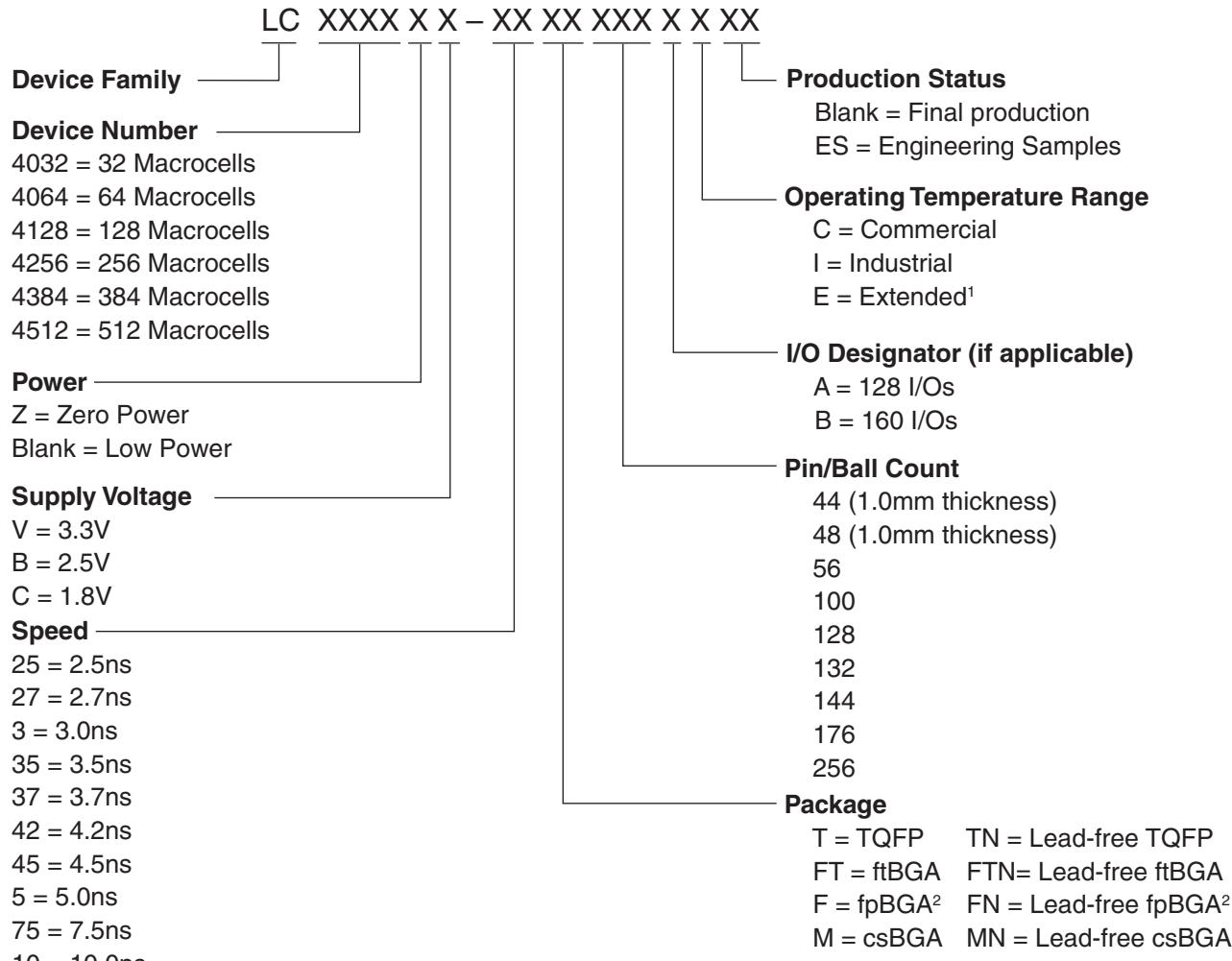
**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:
176-Pin TQFP (Cont.)**

| Pin Number | Bank Number | ispMACH 4256V/B/C/Z | | ispMACH 4384V/B/C | | ispMACH 4512V/B/C | |
|------------|-------------|---------------------|-----|-------------------|-----|-------------------|------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| 60 | 0 | H8 | H^4 | L8 | L^4 | P8 | P^4 |
| 61 | 0 | H6 | H^3 | L6 | L^3 | P6 | P^3 |
| 62 | 0 | H4 | H^2 | L4 | L^2 | P4 | P^2 |
| 63 | 0 | H2 | H^1 | L2 | L^1 | P2 | P^1 |
| 64 | 0 | H0 | H^0 | L0 | L^0 | P0 | P^0 |
| 65 | - | GND | - | GND | - | GND | - |
| 66 | 0 | CLK1/I | - | CLK1/I | - | CLK1/I | - |
| 67 | 1 | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - |
| 68 | 1 | CLK2/I | - | CLK2/I | - | CLK2/I | - |
| 69 | - | VCC | - | VCC | - | VCC | - |
| 70 | 1 | I0 | I^0 | M0 | M^0 | AX0 | AX^0 |
| 71 | 1 | I2 | I^1 | M2 | M^1 | AX2 | AX^1 |
| 72 | 1 | I4 | I^2 | M4 | M^2 | AX4 | AX^2 |
| 73 | 1 | I6 | I^3 | M6 | M^3 | AX6 | AX^3 |
| 74 | 1 | I8 | I^4 | M8 | M^4 | AX8 | AX^4 |
| 75 | 1 | I10 | I^5 | M10 | M^5 | AX10 | AX^5 |
| 76 | 1 | I12 | I^6 | M12 | M^6 | AX12 | AX^6 |
| 77 | 1 | I14 | I^7 | M14 | M^7 | AX14 | AX^7 |
| 78 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 79 | 1 | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - |
| 80 | 1 | J0 | J^0 | N0 | N^0 | BX0 | BX^0 |
| 81 | 1 | J2 | J^1 | N2 | N^1 | BX2 | BX^1 |
| 82 | 1 | J4 | J^2 | N4 | N^2 | BX4 | BX^2 |
| 83 | 1 | J6 | J^3 | N6 | N^3 | BX6 | BX^3 |
| 84 | 1 | J8 | J^4 | N8 | N^4 | BX8 | BX^4 |
| 85 | 1 | J10 | J^5 | N10 | N^5 | BX10 | BX^5 |
| 86 | 1 | J12 | J^6 | N12 | N^6 | BX12 | BX^6 |
| 87 | 1 | J14 | J^7 | N14 | N^7 | BX14 | BX^7 |
| 88 | - | VCC | - | VCC | - | VCC | - |
| 89 | - | NC | - | NC | - | NC | - |
| 90 | - | GND | - | GND | - | GND | - |
| 91 | - | TMS | - | TMS | - | TMS | - |
| 92 | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| 93 | 1 | K14 | K^7 | O14 | O^7 | CX14 | CX^7 |
| 94 | 1 | K12 | K^6 | O12 | O^6 | CX12 | CX^6 |
| 95 | 1 | K10 | K^5 | O10 | O^5 | CX10 | CX^5 |
| 96 | 1 | K8 | K^4 | O8 | O^4 | CX8 | CX^4 |
| 97 | 1 | K6 | K^3 | O6 | O^3 | CX6 | CX^3 |
| 98 | 1 | K4 | K^2 | O4 | O^2 | CX4 | CX^2 |
| 99 | 1 | K2 | K^1 | O2 | O^1 | CX2 | CX^1 |
| 100 | 1 | K0 | K^0 | O0 | O^0 | CX0 | CX^0 |

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:
256-Ball ftBGA/fpBGA (Cont.)**

| Ball Number | I/O Bank | ispMACH 4256V/B/C 128-I/O | | ispMACH 4256V/B/C 160-I/O | | ispMACH 4384V/B/C | | ispMACH 4512V/B/C | |
|-------------|----------|------------------------------|-----|------------------------------|-----|-------------------|------|-------------------|------|
| | | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP | GLB/MC/Pad | ORP |
| R5 | 0 | NC | - | NC | - | NC | - | L4 | L^1 |
| T5 | 0 | NC | - | NC | - | I2 | I^1 | L8 | L^2 |
| R6 | 0 | NC | - | NC | - | I0 | I^0 | L12 | L^3 |
| T6 | 0 | NC | - | H14 | H^9 | G12 | G^6 | M8 | M^2 |
| N7 | 0 | NC | - | H12 | H^8 | G14 | G^7 | M12 | M^3 |
| P7 | 0 | H14 | H^7 | H10 | H^7 | L14 | L^7 | P14 | P^7 |
| R7 | 0 | H12 | H^6 | H9 | H^6 | L12 | L^6 | P12 | P^6 |
| L8 | 0 | H10 | H^5 | H8 | H^5 | L10 | L^5 | P10 | P^5 |
| T7 | 0 | H8 | H^4 | H6 | H^4 | L8 | L^4 | P8 | P^4 |
| M8 | 0 | H6 | H^3 | H4 | H^3 | L6 | L^3 | P6 | P^3 |
| N8 | 0 | H4 | H^2 | H2 | H^2 | L4 | L^2 | P4 | P^2 |
| R8 | 0 | H2 | H^1 | H1 | H^1 | L2 | L^1 | P2 | P^1 |
| P8 | 0 | H0 | H^0 | H0 | H^0 | L0 | L^0 | P0 | P^0 |
| - | - | GND | - | GND | - | GND | - | GND | - |
| T8 | 0 | CLK1/I | - | CLK1/I | - | CLK1/I | - | CLK1/I | - |
| - | 1 | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - |
| N9 | 1 | CLK2/I | - | CLK2/I | - | CLK2/I | - | CLK2/I | - |
| - | - | VCC | - | VCC | - | VCC | - | VCC | - |
| P9 | 1 | I0 | I^0 | I0 | I^0 | M0 | M^0 | AX0 | AX^0 |
| R9 | 1 | I2 | I^1 | I1 | I^1 | M2 | M^1 | AX2 | AX^1 |
| T9 | 1 | I4 | I^2 | I2 | I^2 | M4 | M^2 | AX4 | AX^2 |
| T10 | 1 | I6 | I^3 | I4 | I^3 | M6 | M^3 | AX6 | AX^3 |
| R10 | 1 | I8 | I^4 | I6 | I^4 | M8 | M^4 | AX8 | AX^4 |
| M9 | 1 | I10 | I^5 | I8 | I^5 | M10 | M^5 | AX10 | AX^5 |
| P10 | 1 | I12 | I^6 | I9 | I^6 | M12 | M^6 | AX12 | AX^6 |
| L9 | 1 | I14 | I^7 | I10 | I^7 | M14 | M^7 | AX14 | AX^7 |
| N10 | 1 | NC | - | I12 | I^8 | BX14 | BX^7 | DX0 | DX^0 |
| T11 | 1 | NC | - | I14 | I^9 | BX12 | BX^6 | DX4 | DX^1 |
| R11 | 1 | NC | - | NC | - | P0 | P^0 | EX0 | EX^0 |
| T12 | 1 | NC | - | NC | - | P2 | P^1 | EX4 | EX^1 |
| N12 | 1 | NC | - | NC | - | NC | - | EX8 | EX^2 |
| - | 1 | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - | VCCO (Bank 1) | - |
| - | 1 | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - | GND (Bank 1) | - |
| R12 | 1 | NC | - | NC | - | NC | - | EX12 | EX^3 |
| T13 | 1 | NC | - | J0 | J^0 | BX10 | BX^5 | DX8 | DX^2 |
| P12 | 1 | NC | - | J1 | J^1 | BX8 | BX^4 | DX12 | DX^3 |
| M10 | 1 | J0 | J^0 | J2 | J^2 | N0 | N^0 | BX0 | BX^0 |
| R13 | 1 | J2 | J^1 | J4 | J^3 | N2 | N^1 | BX2 | BX^1 |
| L10 | 1 | J4 | J^2 | J6 | J^4 | N4 | N^2 | BX4 | BX^2 |
| T14 | 1 | J6 | J^3 | J8 | J^5 | N6 | N^3 | BX6 | BX^3 |
| M11 | 1 | J8 | J^4 | J9 | J^6 | N8 | N^4 | BX8 | BX^4 |

Part Number Description



1. For automotive AEC-Q100 compliant devices, refer to the LA-ispmACH 4000V/Z Automotive Family Data Sheet (DS1017).

2. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000 Family Speed Grade Offering

| | -25 | -27 | -3 | -35 | -37 | -42 | -45 | -5 | | -75 | | | -10 |
|-------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| | Com | Ind | Com | Ind | Ext | Ind |
| ispMACH 4032V/B/C | | | | | | | | | | | | | 1 |
| ispMACH 4064V/B/C | | | | | | | | | | | | | 1 |
| ispMACH 4128V/B/C | | | | | | | | | | | | | 1 |
| ispMACH 4256V/B/C | | | | | | | | | | | | | |
| ispMACH 4384V/B/C | | | | | | | | | | | | | |
| ispMACH 4512V/B/C | | | | | | | | | | | | | |
| ispMACH 4032ZC | | | | | | | | | | | | | 1 |
| ispMACH 4064ZC | | | | | | | | | | | | | 1 |
| ispMACH 4128ZC | | | | | | | | | | | | | 1 |
| ispMACH 4256ZC | | | | | | | | | | | | | |

1. 3.3V only.

Ordering Information

Note: ispMACH 4000 devices are all dual marked except the slowest commercial speed grade ispMACH 4000Z devices. For example, the commercial speed grade LC4128C-5T100C is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade ispMACH 4000Z devices are marked as commercial grade only.

Conventional Packaging

ispMACH 4000ZC (Zero Power, 1.8V) Commercial Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|----------|------------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4032ZC | LC4032ZC-35M56C | 32 | 1.8 | 3.5 | csBGA | 56 | 32 | C |
| | LC4032ZC-5M56C | 32 | 1.8 | 5 | csBGA | 56 | 32 | C |
| | LC4032ZC-75M56C | 32 | 1.8 | 7.5 | csBGA | 56 | 32 | C |
| | LC4032ZC-35T48C | 32 | 1.8 | 3.5 | TQFP | 48 | 32 | C |
| | LC4032ZC-5T48C | 32 | 1.8 | 5 | TQFP | 48 | 32 | C |
| | LC4032ZC-75T48C | 32 | 1.8 | 7.5 | TQFP | 48 | 32 | C |
| LC4064ZC | LC4064ZC-37M132C | 64 | 1.8 | 3.7 | csBGA | 132 | 64 | C |
| | LC4064ZC-5M132C | 64 | 1.8 | 5 | csBGA | 132 | 64 | C |
| | LC4064ZC-75M132C | 64 | 1.8 | 7.5 | csBGA | 132 | 64 | C |
| | LC4064ZC-37T100C | 64 | 1.8 | 3.7 | TQFP | 100 | 64 | C |
| | LC4064ZC-5T100C | 64 | 1.8 | 5 | TQFP | 100 | 64 | C |
| | LC4064ZC-75T100C | 64 | 1.8 | 7.5 | TQFP | 100 | 64 | C |
| | LC4064ZC-37M56C | 64 | 1.8 | 3.7 | csBGA | 56 | 32 | C |
| | LC4064ZC-5M56C | 64 | 1.8 | 5 | csBGA | 56 | 32 | C |
| | LC4064ZC-75M56C | 64 | 1.8 | 7.5 | csBGA | 56 | 32 | C |
| | LC4064ZC-37T48C | 64 | 1.8 | 3.7 | TQFP | 48 | 32 | C |
| | LC4064ZC-5T48C | 64 | 1.8 | 5 | TQFP | 48 | 32 | C |
| | LC4064ZC-75T48C | 64 | 1.8 | 7.5 | TQFP | 48 | 32 | C |
| LC4128ZC | LC4128ZC-42M132C | 128 | 1.8 | 4.2 | csBGA | 132 | 96 | C |
| | LC4128ZC-75M132C | 128 | 1.8 | 7.5 | csBGA | 132 | 96 | C |
| | LC4128ZC-42T100C | 128 | 1.8 | 4.2 | TQFP | 100 | 64 | C |
| | LC4128ZC-75T100C | 128 | 1.8 | 7.5 | TQFP | 100 | 64 | C |
| LC4256ZC | LC4256ZC-45T176C | 256 | 1.8 | 4.5 | TQFP | 176 | 128 | C |
| | LC4256ZC-75T176C | 256 | 1.8 | 7.5 | TQFP | 176 | 128 | C |
| | LC4256ZC-45M132C | 256 | 1.8 | 4.5 | csBGA | 132 | 96 | C |
| | LC4256ZC-75M132C | 256 | 1.8 | 7.5 | csBGA | 132 | 96 | C |
| | LC4256ZC-45T100C | 256 | 1.8 | 4.5 | TQFP | 100 | 64 | C |
| | LC4256ZC-75T100C | 256 | 1.8 | 7.5 | TQFP | 100 | 64 | C |

ispMACH 4000ZC (1.8V, Zero Power) Industrial Devices

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|----------|-----------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4032ZC | LC4032ZC-5M56I | 32 | 1.8 | 5 | csBGA | 56 | 32 | I |
| | LC4032ZC-75M56I | 32 | 1.8 | 7.5 | csBGA | 56 | 32 | I |
| | LC4032ZC-5T48I | 32 | 1.8 | 5 | TQFP | 48 | 32 | I |
| | LC4032ZC-75T48I | 32 | 1.8 | 7.5 | TQFP | 48 | 32 | I |

ispMACH 4000B (2.5V) Commercial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|-------------------------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4256B | LC4256B-3FT256AC | 256 | 2.5 | 3 | ftBGA | 256 | 128 | C |
| | LC4256B-5FT256AC | 256 | 2.5 | 5 | ftBGA | 256 | 128 | C |
| | LC4256B-75FT256AC | 256 | 2.5 | 7.5 | ftBGA | 256 | 128 | C |
| | LC4256B-3FT256BC | 256 | 2.5 | 3 | ftBGA | 256 | 160 | C |
| | LC4256B-5FT256BC | 256 | 2.5 | 5 | ftBGA | 256 | 160 | C |
| | LC4256B-75FT256BC | 256 | 2.5 | 7.5 | ftBGA | 256 | 160 | C |
| | LC4256B-3F256AC ¹ | 256 | 2.5 | 3 | fpBGA | 256 | 128 | C |
| | LC4256B-5F256AC ¹ | 256 | 2.5 | 5 | fpBGA | 256 | 128 | C |
| | LC4256B-75F256AC ¹ | 256 | 2.5 | 7.5 | fpBGA | 256 | 128 | C |
| | LC4256B-3F256BC ¹ | 256 | 2.5 | 3 | fpBGA | 256 | 160 | C |
| | LC4256B-5F256BC ¹ | 256 | 2.5 | 5 | fpBGA | 256 | 160 | C |
| | LC4256B-75F256BC ¹ | 256 | 2.5 | 7.5 | fpBGA | 256 | 160 | C |
| | LC4256B-3T176C | 256 | 2.5 | 3 | TQFP | 176 | 128 | C |
| | LC4256B-5T176C | 256 | 2.5 | 5 | TQFP | 176 | 128 | C |
| | LC4256B-75T176C | 256 | 2.5 | 7.5 | TQFP | 176 | 128 | C |
| LC4384B | LC4384B-35FT256C | 384 | 2.5 | 3.5 | ftBGA | 256 | 192 | C |
| | LC4384B-5FT256C | 384 | 2.5 | 5 | ftBGA | 256 | 192 | C |
| | LC4384B-75FT256C | 384 | 2.5 | 7.5 | ftBGA | 256 | 192 | C |
| | LC4384B-35F256C ¹ | 384 | 2.5 | 3.5 | fpBGA | 256 | 192 | C |
| | LC4384B-5F256C ¹ | 384 | 2.5 | 5 | fpBGA | 256 | 192 | C |
| | LC4384B-75F256C ¹ | 384 | 2.5 | 7.5 | fpBGA | 256 | 192 | C |
| | LC4384B-35T176C | 384 | 2.5 | 3.5 | TQFP | 176 | 128 | C |
| | LC4384B-5T176C | 384 | 2.5 | 5 | TQFP | 176 | 128 | C |
| LC4512B | LC4512B-35FT256C | 512 | 2.5 | 3.5 | ftBGA | 256 | 208 | C |
| | LC4512B-5FT256C | 512 | 2.5 | 5 | ftBGA | 256 | 208 | C |
| | LC4512B-75FT256C | 512 | 2.5 | 7.5 | ftBGA | 256 | 208 | C |
| | LC4512B-35F256C ¹ | 512 | 2.5 | 3.5 | fpBGA | 256 | 208 | C |
| | LC4512B-5F256C ¹ | 512 | 2.5 | 5 | fpBGA | 256 | 208 | C |
| | LC4512B-75F256C ¹ | 512 | 2.5 | 7.5 | fpBGA | 256 | 208 | C |
| | LC4512B-35T176C | 512 | 2.5 | 3.5 | TQFP | 176 | 128 | C |
| | LC4512B-5T176C | 512 | 2.5 | 5 | TQFP | 176 | 128 | C |
| | LC4512B-75T176C | 512 | 2.5 | 7.5 | TQFP | 176 | 128 | C |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Commercial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|-------------------------------|------------|---------|-----------------|---------|----------------|-----|-------|
| LC4128V | LC4128V-27T144C | 128 | 3.3 | 2.7 | TQFP | 144 | 96 | C |
| | LC4128V-5T144C | 128 | 3.3 | 5 | TQFP | 144 | 96 | C |
| | LC4128V-75T144C | 128 | 3.3 | 7.5 | TQFP | 144 | 96 | C |
| | LC4128V-27T128C | 128 | 3.3 | 2.7 | TQFP | 128 | 92 | C |
| | LC4128V-5T128C | 128 | 3.3 | 5 | TQFP | 128 | 92 | C |
| | LC4128V-75T128C | 128 | 3.3 | 7.5 | TQFP | 128 | 92 | C |
| | LC4128V-27T100C | 128 | 3.3 | 2.7 | TQFP | 100 | 64 | C |
| | LC4128V-5T100C | 128 | 3.3 | 5 | TQFP | 100 | 64 | C |
| | LC4128V-75T100C | 128 | 3.3 | 7.5 | TQFP | 100 | 64 | C |
| | | | | | | | | |
| LC4256V | LC4256V-3FT256AC | 256 | 3.3 | 3 | ftBGA | 256 | 128 | C |
| | LC4256V-5FT256AC | 256 | 3.3 | 5 | ftBGA | 256 | 128 | C |
| | LC4256V-75FT256AC | 256 | 3.3 | 7.5 | ftBGA | 256 | 128 | C |
| | LC4256V-3FT256BC | 256 | 3.3 | 3 | ftBGA | 256 | 160 | C |
| | LC4256V-5FT256BC | 256 | 3.3 | 5 | ftBGA | 256 | 160 | C |
| | LC4256V-75FT256BC | 256 | 3.3 | 7.5 | ftBGA | 256 | 160 | C |
| | LC4256V-3F256AC ¹ | 256 | 3.3 | 3 | fpBGA | 256 | 128 | C |
| | LC4256V-5F256AC ¹ | 256 | 3.3 | 5 | fpBGA | 256 | 128 | C |
| | LC4256V-75F256AC ¹ | 256 | 3.3 | 7.5 | fpBGA | 256 | 128 | C |
| | LC4256V-3F256BC ¹ | 256 | 3.3 | 3 | fpBGA | 256 | 160 | C |
| | LC4256V-5F256BC ¹ | 256 | 3.3 | 5 | fpBGA | 256 | 160 | C |
| | LC4256V-75F256BC ¹ | 256 | 3.3 | 7.5 | fpBGA | 256 | 160 | C |
| | LC4256V-3T176C | 256 | 3.3 | 3 | TQFP | 176 | 128 | C |
| | LC4256V-5T176C | 256 | 3.3 | 5 | TQFP | 176 | 128 | C |
| | LC4256V-75T176C | 256 | 3.3 | 7.5 | TQFP | 176 | 128 | C |
| | LC4256V-3T144C | 256 | 3.3 | 3 | TQFP | 144 | 96 | C |
| | LC4256V-5T144C | 256 | 3.3 | 5 | TQFP | 144 | 96 | C |
| | LC4256V-75T144C | 256 | 3.3 | 7.5 | TQFP | 144 | 96 | C |
| | LC4256V-3T100C | 256 | 3.3 | 3 | TQFP | 100 | 64 | C |
| | LC4256V-5T100C | 256 | 3.3 | 5 | TQFP | 100 | 64 | C |
| | LC4256V-75T100C | 256 | 3.3 | 7.5 | TQFP | 100 | 64 | C |
| LC4384V | LC4384V-35FT256C | 384 | 3.3 | 3.5 | ftBGA | 256 | 192 | C |
| | LC4384V-5FT256C | 384 | 3.3 | 5 | ftBGA | 256 | 192 | C |
| | LC4384V-75FT256C | 384 | 3.3 | 7.5 | ftBGA | 256 | 192 | C |
| | LC4384V-35F256C ¹ | 384 | 3.3 | 3.5 | fpBGA | 256 | 192 | C |
| | LC4384V-5F256C ¹ | 384 | 3.3 | 5 | fpBGA | 256 | 192 | C |
| | LC4384V-75F256C ¹ | 384 | 3.3 | 7.5 | fpBGA | 256 | 192 | C |
| | LC4384V-35T176C | 384 | 3.3 | 3.5 | TQFP | 176 | 128 | C |
| | LC4384V-5T176C | 384 | 3.3 | 5 | TQFP | 176 | 128 | C |
| | LC4384V-75T176C | 384 | 3.3 | 7.5 | TQFP | 176 | 128 | C |

ispMACH 4000B (2.5V) Lead-Free Industrial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|--------------------------------|------------|---------|-----------------|-----------------|----------------|-----|-------|
| LC4128B | LC4128B-5TN128I | 128 | 2.5 | 5 | Lead-Free TQFP | 128 | 92 | I |
| | LC4128B-75TN128I | 128 | 2.5 | 7.5 | Lead-Free TQFP | 128 | 92 | I |
| | LC4128B-10TN128I | 128 | 2.5 | 10 | Lead-Free TQFP | 128 | 92 | I |
| | LC4128B-5TN100I | 128 | 2.5 | 5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4128B-75TN100I | 128 | 2.5 | 7.5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4128B-10TN100I | 128 | 2.5 | 10 | Lead-Free TQFP | 100 | 64 | I |
| LC4256B | LC4256B-5FTN256AI | 256 | 2.5 | 5 | Lead-Free ftBGA | 256 | 128 | I |
| | LC4256B-75FTN256AI | 256 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 128 | I |
| | LC4256B-10FTN256AI | 256 | 2.5 | 10 | Lead-Free ftBGA | 256 | 128 | I |
| | LC4256B-5FTN256BI | 256 | 2.5 | 5 | Lead-Free ftBGA | 256 | 160 | I |
| | LC4256B-75FTN256BI | 256 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 160 | I |
| | LC4256B-10FTN256BI | 256 | 2.5 | 10 | Lead-Free ftBGA | 256 | 160 | I |
| | LC4256B-5FN256AI ¹ | 256 | 2.5 | 5 | Lead-Free fpBGA | 256 | 128 | I |
| | LC4256B-75FN256AI ¹ | 256 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 128 | I |
| | LC4256B-10FN256AI ¹ | 256 | 2.5 | 10 | Lead-Free fpBGA | 256 | 128 | I |
| | LC4256B-5FN256BI ¹ | 256 | 2.5 | 5 | Lead-Free fpBGA | 256 | 160 | I |
| | LC4256B-75FN256BI ¹ | 256 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 160 | I |
| | LC4256B-10FN256BI ¹ | 256 | 2.5 | 10 | Lead-Free fpBGA | 256 | 160 | I |
| | LC4256B-5TN176I | 256 | 2.5 | 5 | Lead-Free TQFP | 176 | 128 | I |
| | LC4256B-75TN176I | 256 | 2.5 | 7.5 | Lead-Free TQFP | 176 | 128 | I |
| | LC4256B-10TN176I | 256 | 2.5 | 10 | Lead-Free TQFP | 176 | 128 | I |
| | LC4256B-5TN100I | 256 | 2.5 | 5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4256B-75TN100I | 256 | 2.5 | 7.5 | Lead-Free TQFP | 100 | 64 | I |
| | LC4256B-10TN100I | 256 | 2.5 | 10 | Lead-Free TQFP | 100 | 64 | I |
| LC4384B | LC4384B-5FTN256I | 384 | 2.5 | 5 | Lead-Free ftBGA | 256 | 192 | I |
| | LC4384B-75FTN256I | 384 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 192 | I |
| | LC4384B-10FTN256I | 384 | 2.5 | 10 | Lead-Free ftBGA | 256 | 192 | I |
| | LC4384B-5FN256I ¹ | 384 | 2.5 | 5 | Lead-Free fpBGA | 256 | 192 | I |
| | LC4384B-75FN256I ¹ | 384 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 192 | I |
| | LC4384B-10FN256I ¹ | 384 | 2.5 | 10 | Lead-Free fpBGA | 256 | 192 | I |
| | LC4384B-5TN176I | 384 | 2.5 | 5 | Lead-Free TQFP | 176 | 128 | I |
| | LC4384B-75TN176I | 384 | 2.5 | 7.5 | Lead-Free TQFP | 176 | 128 | I |
| | LC4384B-10TN176I | 384 | 2.5 | 10 | Lead-Free TQFP | 176 | 128 | I |
| LC4512B | LC4512B-5FTN256I | 512 | 2.5 | 5 | Lead-Free ftBGA | 256 | 208 | I |
| | LC4512B-75FTN256I | 512 | 2.5 | 7.5 | Lead-Free ftBGA | 256 | 208 | I |
| | LC4512B-10FTN256I | 512 | 2.5 | 10 | Lead-Free ftBGA | 256 | 208 | I |
| | LC4512B-5FN256I ¹ | 512 | 2.5 | 5 | Lead-Free fpBGA | 256 | 208 | I |
| | LC4512B-75FN256I ¹ | 512 | 2.5 | 7.5 | Lead-Free fpBGA | 256 | 208 | I |
| | LC4512B-10FN256I ¹ | 512 | 2.5 | 10 | Lead-Free fpBGA | 256 | 208 | I |
| | LC4512B-5TN176I | 512 | 2.5 | 5 | Lead-Free TQFP | 176 | 128 | I |
| | LC4512B-75TN176I | 512 | 2.5 | 7.5 | Lead-Free TQFP | 176 | 128 | I |
| | LC4512B-10TN176I | 512 | 2.5 | 10 | Lead-Free TQFP | 176 | 128 | I |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

ispMACH 4000V (3.3V) Lead-Free Industrial Devices (Cont.)

| Device | Part Number | Macrocells | Voltage | t _{PD} | Package | Pin/Ball Count | I/O | Grade |
|---------|--------------------------------|------------|---------|-----------------|-----------------|----------------|-----|-------|
| LC4256V | LC4256V-5FTN256AI | 256 | 3.3 | 5 | Lead-free ftBGA | 256 | 128 | I |
| | LC4256V-75FTN256AI | 256 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 128 | I |
| | LC4256V-10FTN256AI | 256 | 3.3 | 10 | Lead-free ftBGA | 256 | 128 | I |
| | LC4256V-5FTN256BI | 256 | 3.3 | 5 | Lead-free ftBGA | 256 | 160 | I |
| | LC4256V-75FTN256BI | 256 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 160 | I |
| | LC4256V-10FTN256BI | 256 | 3.3 | 10 | Lead-free ftBGA | 256 | 160 | I |
| | LC4256V-5FN256AI ¹ | 256 | 3.3 | 5 | Lead-free fpBGA | 256 | 128 | I |
| | LC4256V-75FN256AI ¹ | 256 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 128 | I |
| | LC4256V-10FN256AI ¹ | 256 | 3.3 | 10 | Lead-free fpBGA | 256 | 128 | I |
| | LC4256V-5FN256BI ¹ | 256 | 3.3 | 5 | Lead-free fpBGA | 256 | 160 | I |
| | LC4256V-75FN256BI ¹ | 256 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 160 | I |
| | LC4256V-10FN256BI ¹ | 256 | 3.3 | 10 | Lead-free fpBGA | 256 | 160 | I |
| | LC4256V-5TN176I | 256 | 3.3 | 5 | Lead-free TQFP | 176 | 128 | I |
| | LC4256V-75TN176I | 256 | 3.3 | 7.5 | Lead-free TQFP | 176 | 128 | I |
| | LC4256V-10TN176I | 256 | 3.3 | 10 | Lead-free TQFP | 176 | 128 | I |
| | LC4256V-5TN144I | 256 | 3.3 | 5 | Lead-free TQFP | 144 | 96 | I |
| | LC4256V-75TN144I | 256 | 3.3 | 7.5 | Lead-free TQFP | 144 | 96 | I |
| | LC4256V-10TN144I | 256 | 3.3 | 10 | Lead-free TQFP | 144 | 96 | I |
| | LC4256V-5TN100I | 256 | 3.3 | 5 | Lead-free TQFP | 100 | 64 | I |
| | LC4256V-75TN100I | 256 | 3.3 | 7.5 | Lead-free TQFP | 100 | 64 | I |
| | LC4256V-10TN100I | 256 | 3.3 | 10 | Lead-free TQFP | 100 | 64 | I |
| LC4384V | LC4384V-5FTN256I | 384 | 3.3 | 5 | Lead-free ftBGA | 256 | 192 | I |
| | LC4384V-75FTN256I | 384 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 192 | I |
| | LC4384V-10FTN256I | 384 | 3.3 | 10 | Lead-free ftBGA | 256 | 192 | I |
| | LC4384V-5FN256I ¹ | 384 | 3.3 | 5 | Lead-free fpBGA | 256 | 192 | I |
| | LC4384V-75FN256I ¹ | 384 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 192 | I |
| | LC4384V-10FN256I ¹ | 384 | 3.3 | 10 | Lead-free fpBGA | 256 | 192 | I |
| | LC4384V-5TN176I | 384 | 3.3 | 5 | Lead-free TQFP | 176 | 128 | I |
| | LC4384V-75TN176I | 384 | 3.3 | 7.5 | Lead-free TQFP | 176 | 128 | I |
| LC4512V | LC4512V-5FTN256I | 512 | 3.3 | 5 | Lead-free ftBGA | 256 | 208 | I |
| | LC4512V-75FTN256I | 512 | 3.3 | 7.5 | Lead-free ftBGA | 256 | 208 | I |
| | LC4512V-10FTN256I | 512 | 3.3 | 10 | Lead-free ftBGA | 256 | 208 | I |
| | LC4512V-5FN256I ¹ | 512 | 3.3 | 5 | Lead-free fpBGA | 256 | 208 | I |
| | LC4512V-75FN256I ¹ | 512 | 3.3 | 7.5 | Lead-free fpBGA | 256 | 208 | I |
| | LC4512V-10FN256I ¹ | 512 | 3.3 | 10 | Lead-free fpBGA | 256 | 208 | I |
| | LC4512V-5TN176I | 512 | 3.3 | 5 | Lead-free TQFP | 176 | 128 | I |
| | LC4512V-75TN176I | 512 | 3.3 | 7.5 | Lead-free TQFP | 176 | 128 | I |
| | LC4512V-10TN176I | 512 | 3.3 | 10 | Lead-free TQFP | 176 | 128 | I |

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.